

NVHL025N65S3

MOSFET – Power, N-Channel, Automotive SUPERFET® III, Easy-drive 650 V, 75 A, 25 mΩ

Description

SuperFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SuperFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

Features

- AEC-Q101 Qualified
- Max Junction Temperature 150°C
- Typ. $R_{DS(on)}$ = 19.9 mΩ
- Ultra Low Gate Charge (Typ. Q_G = 236 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 2062 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

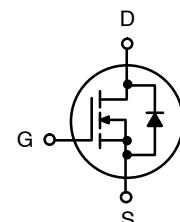
- Automotive PHEV-BEV DC-DC Converter
- Automotive Onboard Charger for PHEV-BEV



ON Semiconductor®

www.onsemi.com

BV_{DSS}	$R_{DS(on)\text{ MAX}}$	$I_D \text{ MAX}$
650 V	25 mΩ @ 10 V	75 A

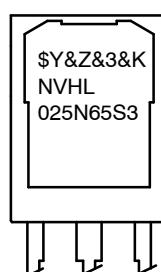


N-Channel MOSFET



TO-247-3LD
CASE 340CX

MARKING DIAGRAM



\$Y = ON Semiconductor Logo
&Z = Assembly Plant Code
&3 = Numeric Date Code
&K = Lot Code
NVHL025N65S3 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

NVHL025N65S3

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Symbol	Parameter		Value	Unit
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	DC Positive	30	V
		AC Positive, (f > 1 Hz)	30	V
		AC Negative, (f > 1 Hz)	-20	V
I _D	Drain Current	Continuous (T _C = 25°C)	75	A
		Continuous (T _C = 100°C)	65.8	A
I _{DM}	Pulsed Drain Current	Pulsed (Note 1)	187.5	A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2025	mJ
E _{AR}	Repetitive Avalanche (Note 1)		5.95	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	V/ns
P _D	Power Dissipation	(T _C = 25°C)	595	W
		Derate Above 25°C	4.76	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. I_{AS} = 15 A, R_G = 25 Ω, starting T_J = 25°C.
3. I_{SD} < 75 A, di/dt ≤ 200 A/ms, V_{DD} ≤ BVDSS, starting T_J = 25°C.
4. Essentially independent of operating temperature typical characteristics.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R _{θJ C}	Thermal Resistance, Junction to Case, Max	0.21	°C/W
R _{θJ A}	Thermal Resistance, Junction to Ambient, Max	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Shipping (Qty / Packing)
NVHL025N65S3	NVHL025N65S3	TO-247-3LD	Tube	30 Units / Tube

NVHL025N65S3

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
--------	-----------	-----------------	-----	-----	-----	------

OFF CHARACTERISTICS

BV _{DSS}	Drain-to-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C	650	713	–	V
		V _{GS} = 0 V, I _D = 1 mA, T _J = 150°C	650	755	–	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	–	0.34	–	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	–	0.30	1	μA
		V _{DS} = 520 V, V _{GS} = 0 V, T _c = 125°C	–	7.92	–	
I _{GSS}	Gate to Body Leakage Current	V _{GS} = +30 V, V _{DS} = 0 V	–	5.27	+100	nA
		V _{GS} = –20 V, V _{DS} = 0 V	–	2.65	–100	nA

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 3.0 mA	2.5	3.56	4.5	V
R _{D(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 37.5 A, T _J = 25°C	–	19.9	25	mΩ
		V _{GS} = 10 V, I _D = 37.5 A, T _J = 100°C	–	34.6	–	mΩ
g _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 75 A	–	78.5	–	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	–	7330	–	pF
C _{oss}	Output Capacitance		–	197	–	pF
C _{rss}	Reverse Transfer Capacitance		–	33.6	–	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	–	2062	–	pF
C _{oss(er.)}	Energy Related Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	–	285	–	pF
Q _{g(tot)}	Total Gate Charge	V _{DS} = 400 V, V _{GS} = 10 V, I _D = 75 A (Note 4)	–	236	–	nC
Q _{gs}	Gate to Source Gate Charge		–	59.3	–	nC
Q _{gd}	Gate to Drain "Miller" Charge		–	97.3	–	nC
R _G	Gate Resistance	f = 1 MHz	–	0.818	–	mΩ

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 75 A, V _{GS} = 10 V, R _G = 2 Ω (Note 4)	–	43.3	–	ns
t _r	Turn-On Rise Time		–	109	–	ns
t _{d(off)}	Turn-Off Delay Time		–	120	–	ns
t _f	Fall Time		–	107	–	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

I _S	Maximum Continuous Drain to Source Diode Forward Current	–	–	75	A	
I _{SM}	Maximum Plused Drain to Source Diode Forward Current	–	–	300	A	
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 37.5 A	–	0.88	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 75 A dI _F /dt = 100 A/μs	–	714	–	nS
	Reverse Recovery Charge		–	26.4	–	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

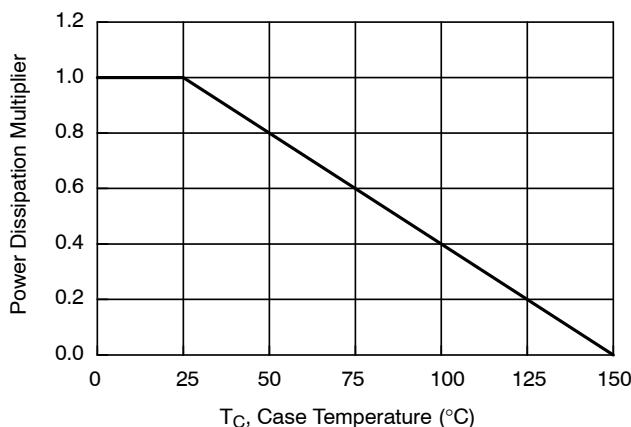


Figure 1. Normalized Power Dissipation vs. Case Temperature

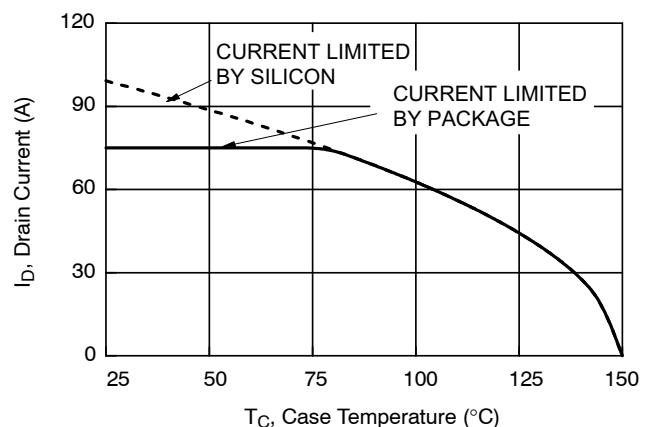


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

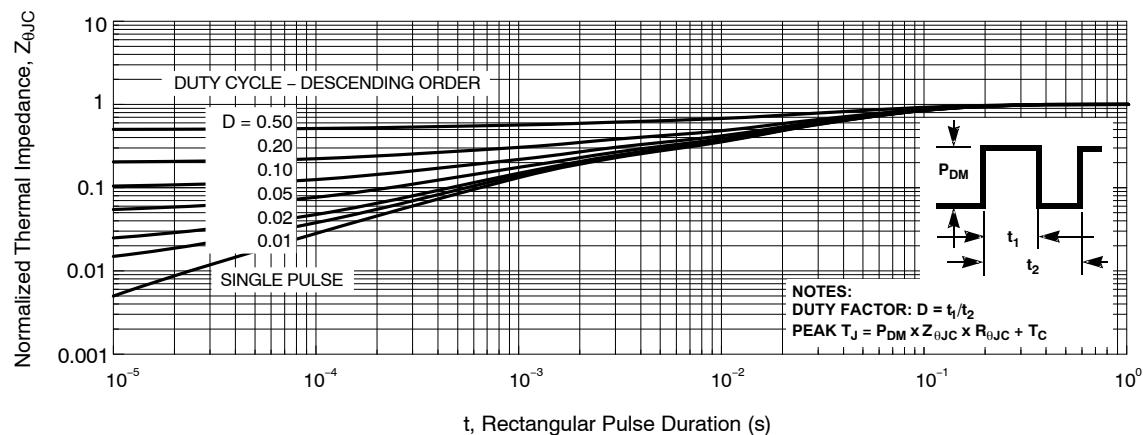


Figure 3. Normalized Maximum Transient Thermal Impedance

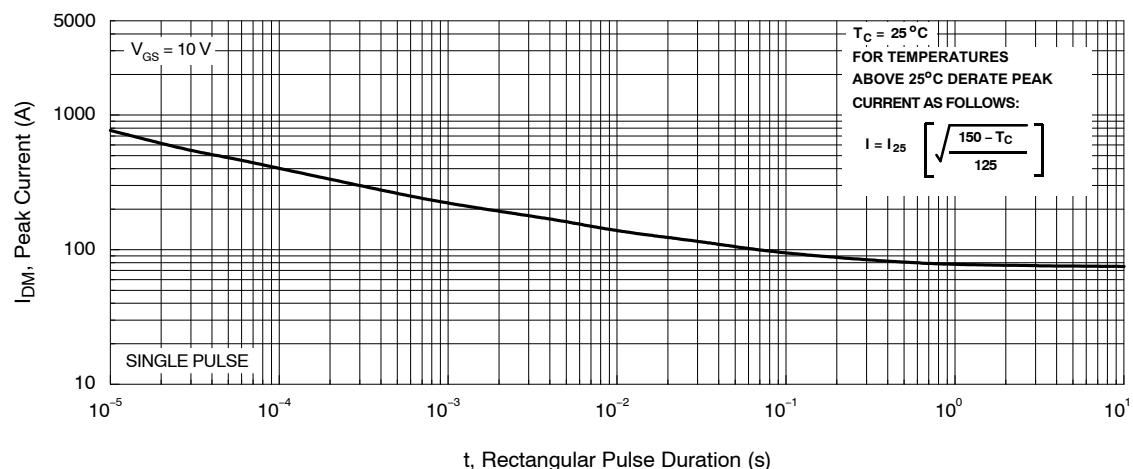
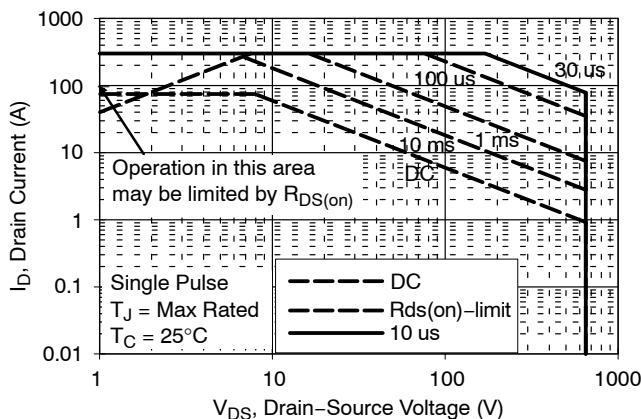
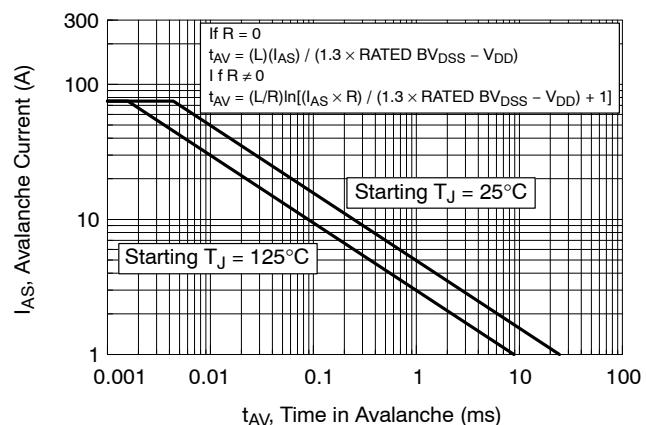
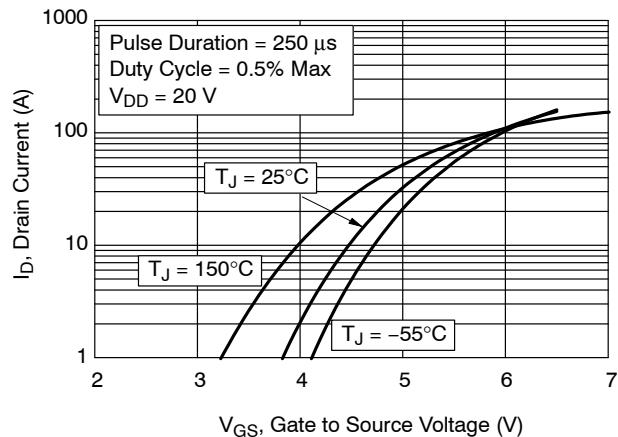
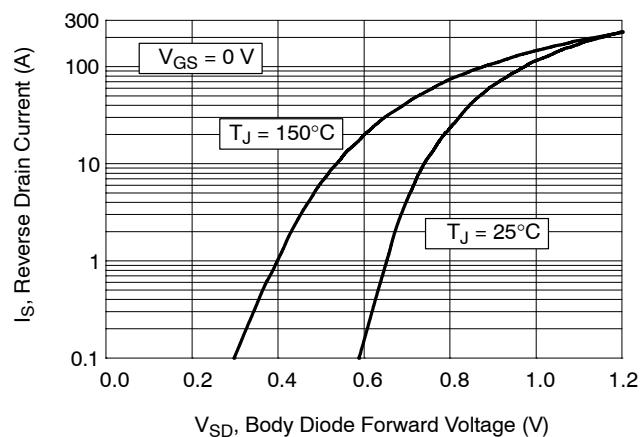
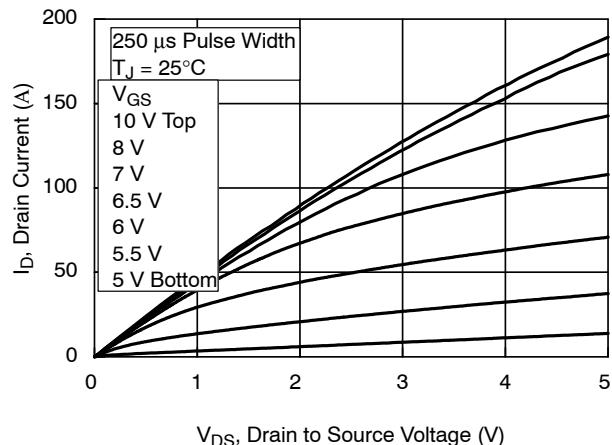
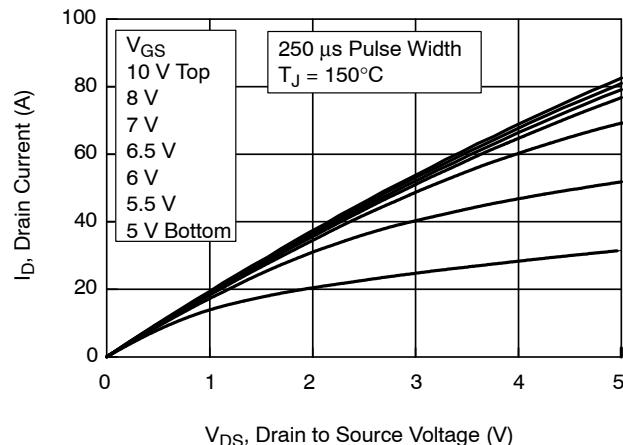
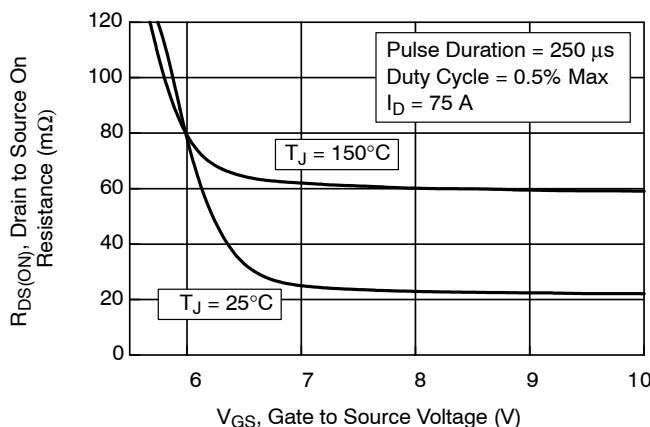
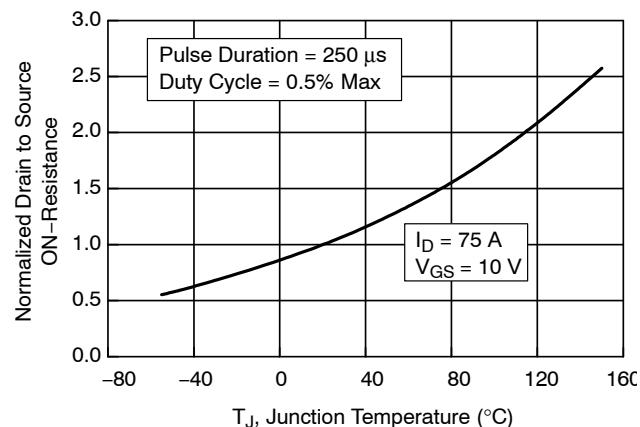
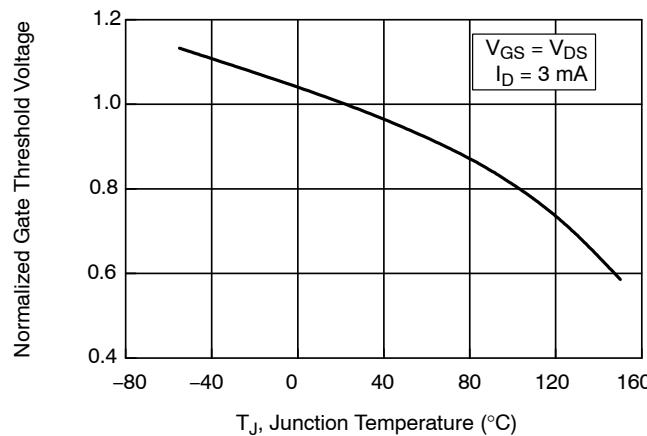
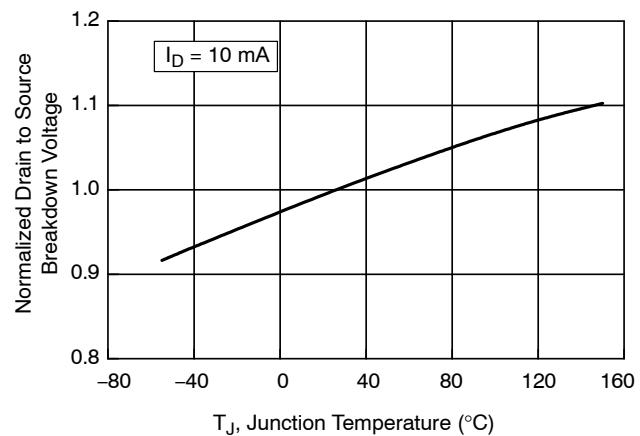
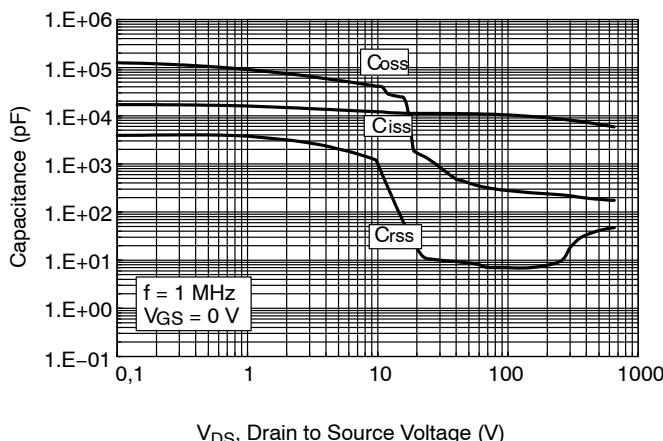
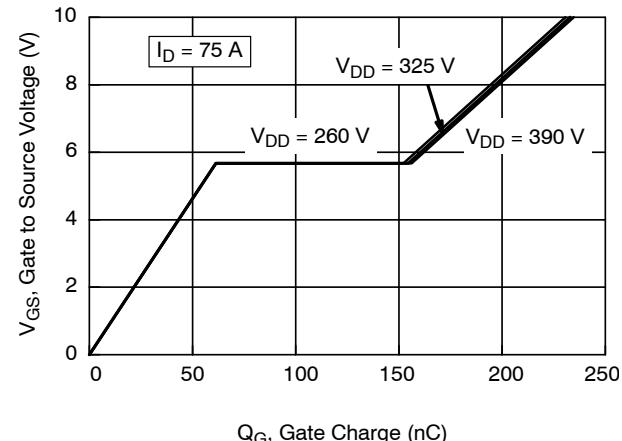


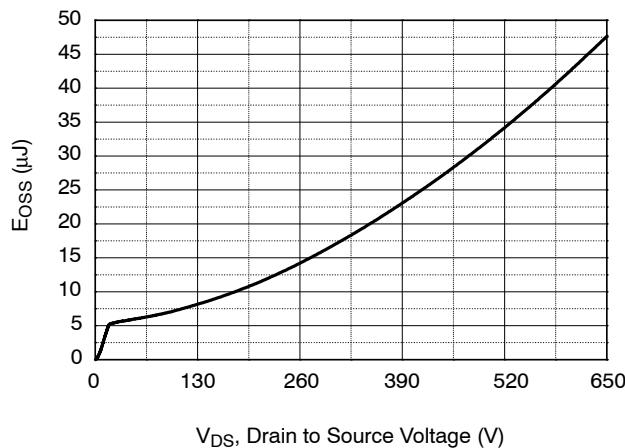
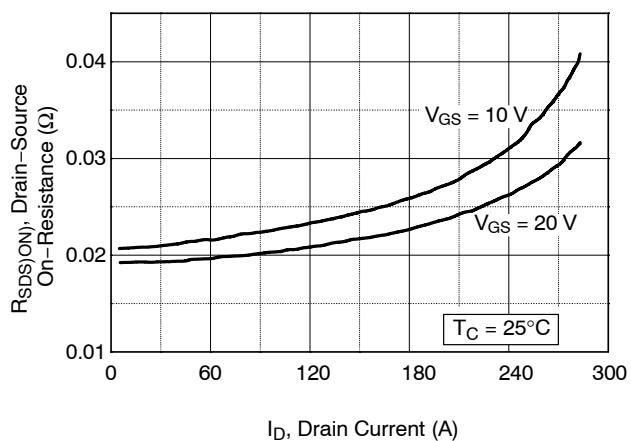
Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)

Figure 5. Forward Bias Safe Operating Area


NOTES: Refer to ON Semiconductor Application Notes AN7514 and AN7515

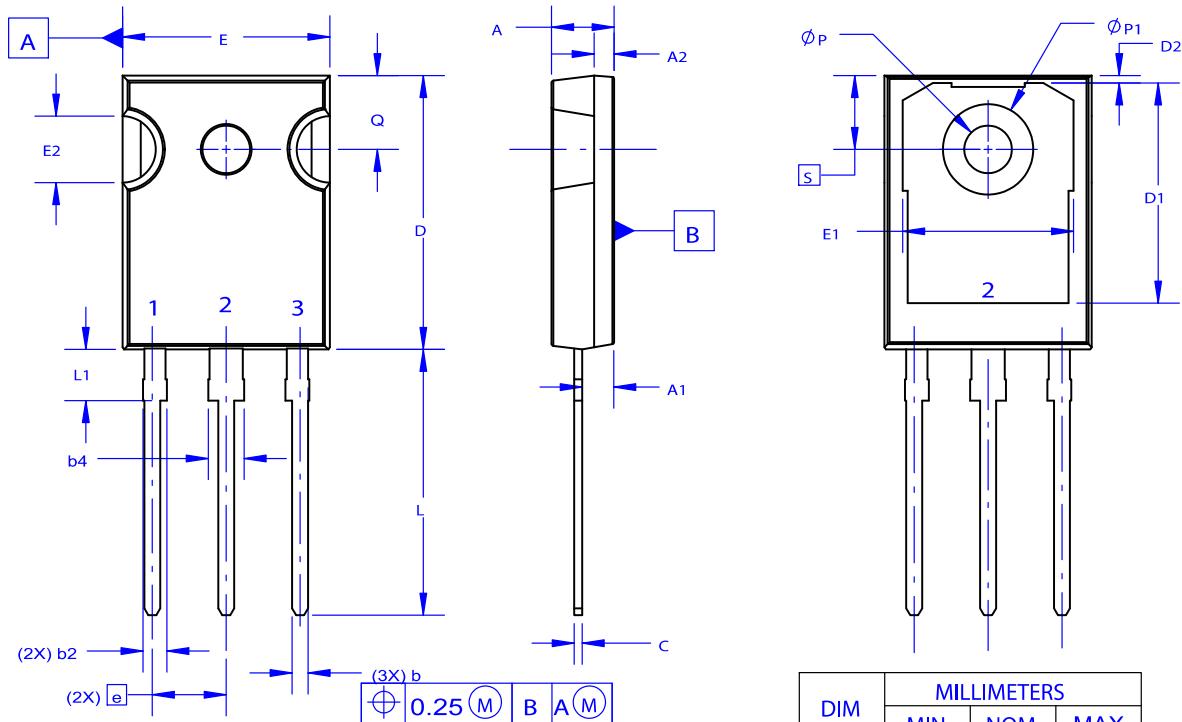
Figure 6. Unclamped Inductive Switching Capability

Figure 7. Transfer Characteristic

Figure 8. Forward Diode Characteristics

Figure 9. Saturation Characteristics

Figure 10. Saturation Characteristics

TYPICAL CHARACTERISTICS (continued)

Figure 11. $R_{DS(ON)}$ vs. Gate Voltage

Figure 12. Normalized $R_{DS(ON)}$ vs. Junction Temperature

Figure 13. Normalized Gate Threshold Voltage vs. Temperature

Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

Figure 15. Capacitance vs. Drain to Source Volatage

Figure 16. Gate Charge vs. Gate to Source Voltage

TYPICAL CHARACTERISTICS (continued)**Figure 17. E_{OSS} vs. Drain to Source Voltage****Figure 18. On-Resistance Variation vs. Drain Current and Gate Voltage**

PACKAGE DIMENSIONS

TO-247-3LD
CASE 340CX
ISSUE O



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
$\emptyset P$	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
$\emptyset P1$	6.60	6.80	7.00

SUPERFET is registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor](#):

[NVHL025N65S3](#)